

2018 International Conference on Materials Engineering and Applications (ICMEA 2018)

Bali, Indonesia

January 14-16, 2018



Conference Introduction

2018 International Conference on Materials Engineering and Applications (ICMEA 2018: <http://www.icmea.org/>) will be held in Bali, Indonesia during January 14-16, 2018.

It provides an opportunity for the delegates to meet, interact and exchange new ideas in the various areas of Materials Science especially on materials engineering and application. ICMEA 2018 aims in proclaim knowledge and share new ideas amongst the professionals, industrialists and students from research areas of materials engineering and application to share their research experiences and indulge in interactive discussions and special sessions at the event.

Good News

1. Publication

Option One: IOP Conference Series: Materials Science and Engineering (ISSN: 1757-899X), which is indexed by EI Compendex, Scopus, Thomson Reuters (WoS), Inspec, et al.



Option Two: International Journal of Materials Science and Engineering (IJMSE, ISSN: 2315-4527).



2. Famous professors as Speakers

Prof. Stephen John Pennycook, National University of Singapore, Singapore

Prof. ShaoJun Guo, Peking University, China;

Prof. Takashige Omatsu, Chiba University, Japan;

Prof. Frank Otremba, Federal Institute for Material Research and Testing, Germany;

Prof. Tjokorda Gde Tirta Nindhia, Udayana University, Indonesia.

3. Academic Visit

There will be a one-day academic visit in Bali on January 16, 2018.

Important Dates

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Paper Submission	before November 20, 2017
Notification of Acceptance	on December 05, 2017
Registration	before December 15, 2017
Conference Dates	January 14-15, 2018
Academic Visit	January 16, 2018

Call for Papers

Topics of interest for submission include, but are not limited to: Metallic Alloys, Tool Materials, Superplastic Materials, Ceramics and Glasses, Composites, Amorphous Materials, Nanomaterials, Biomaterials, Multifunctional Materials, Smart Materials, Engineering Polymers, Functional materials, Nuclear fuel materials, Biomaterials, sensors and surfaces, Thin Film Chalcogenide Photovoltaic Materials, Nuclear Materials IV, Magnetic Materials, Multi Functional Magnetic Materials, Superconducting Materials, Structured Materials, Spintronics Materials and Devices, Hard/Soft Magnetic Materials, Crosscutting materials, Ductility, Crack Resistance, Fatigue, Creep-resistance, Fracture Mechanics, Mechanical Properties, Electrical Properties, and Magnetic Properties, Corrosion, Erosion, Wear Resistance, Non-Destructive Testing, Reliability Assessment, Toxicity, Working Properties of Materials and Products, Large Scale Applications, Electronics Applications, Materials Chemistry Classical Analytical Chemistry, Instrumental Analysis, Optical Analysis, Polymer Science, Structural Chemistry, Material Shaping. (For more information, please visit <http://www.icmea.org/cfp.html>)

Submission Methods

1. Easy Chair System:

<http://www.easychair.org/conferences/?conf=icmea2018>

2. Conference Email Address: icmea@cbees.net

Conference Specialist: Ms. Tammy Luo

E-mail: icmea@cbees.net

Contact Tel: +852-3500-0137 (Hong Kong)

Contact us